Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	3139300	dic$3 or cut$4 or scrib$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/03 12:48
L2	436803	plasma$	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/03 12:48
L3	1864373	polish$ or thinning or grind$ or ground	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/03 12:50
L4	9361	1 with 2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/03 12:51
L5	1955	3 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/03 12:51
L6	591454	mask$	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/03 12:52
L7	628	5 and 6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/03 12:54

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	6	(("6171940") or ("6764903") or ("6482726") or ("6576562") or ("6440870") or ("6682996")).PN.	US-PGPUB; USPAT	OR	OFF	2005/01/27 07:07
S2	8134	plasma$ with (dic$4 or cut$4 or scrib$4 or divid$4)	US-PGPUB; USPAT	OR	ON	2005/01/27 07:08
S3	188185	(wafer or substrate) with (polish$4 or thin$4 or ground$ or grind$4)	US-PGPUB; USPAT	OR	ON	2005/01/27 07:09
S4	1605	S2 and S3	US-PGPUB; USPAT	OR	ON	2005/01/27 07:10